

PFM-HDS

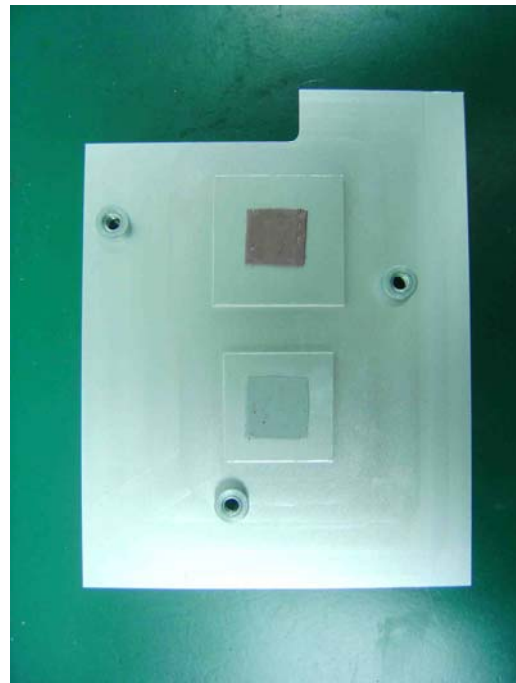
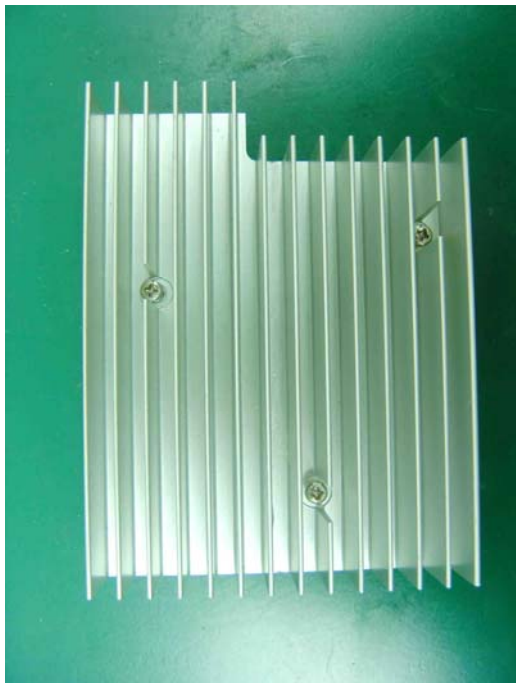
Thermal Image Analysis Report

| | | | | |
|---------------------|---|-------|-------|-------------|
| Summary | <input type="checkbox"/> Pass <input type="checkbox"/> Fail <input checked="" type="checkbox"/> Pass with Deviation <p style="text-align: center;">Comment: <u>Temperature points at 5 components were estimated to be in marginal temperature points in comparion with component datasheets.</u></p> | | | |
| Test Result Summary | | | | |
| | Critical | Major | Minor | Enhancement |
| Defect Found | 0 | 0 | 0 | 5 |
| Defect Unsolved | 0 | 0 | 0 | 5 |

| | | |
|----------------|----------|---------------|
| Issue date | Approval | Test Engineer |
| 2013 / 02 / 08 | Tom Lin | Rex Chang |

Sample Configuration & Quantity Under Test

- Model name : PFM-HDS A0.2
- CPU Board : PFM-HDS A0.2
- CPU : AMD G-T16R / 615MHz
- Memory : DSL 4GB / DDR3 10660 / ELPIDA J2108BCSE-DJ-F
- 2.5" SATA HDD : FUJITSU MHZ2080BH G2 / 80GB
- BIOS : PFM-HDS R0.3(PFHDAM03) (12/27/2012)
- Test Software : Windows 7 / Run PassMark Burn In Test 7.0 Pro
- Power : AT Power
- Heat Sink :



Thermal Image Analysis

1. Test Date: 2013-02-07

2. Test Product: PFM-HDS A0.2

3. Test Site: AAEON QE Dept.

4. Temperature Measurement:

4.1. 40 Channel Thermal Recorder:

4.1.1 YOKOGAWA Inc,

4.2.2 Model: DA100-13-1D

Date of Calibration: 2012/10/08

Serial Number: 12A323190

4.2. IR Scanner: Infrared Camera

4.2.1 NEC Avio Infrared Technologies Co., Ltd.

4.2.2 Model: Thermo GEAR G100W2-D

Date of Calibration: 2013/01/08

Serial Number: 1051444

5. Test Condition:

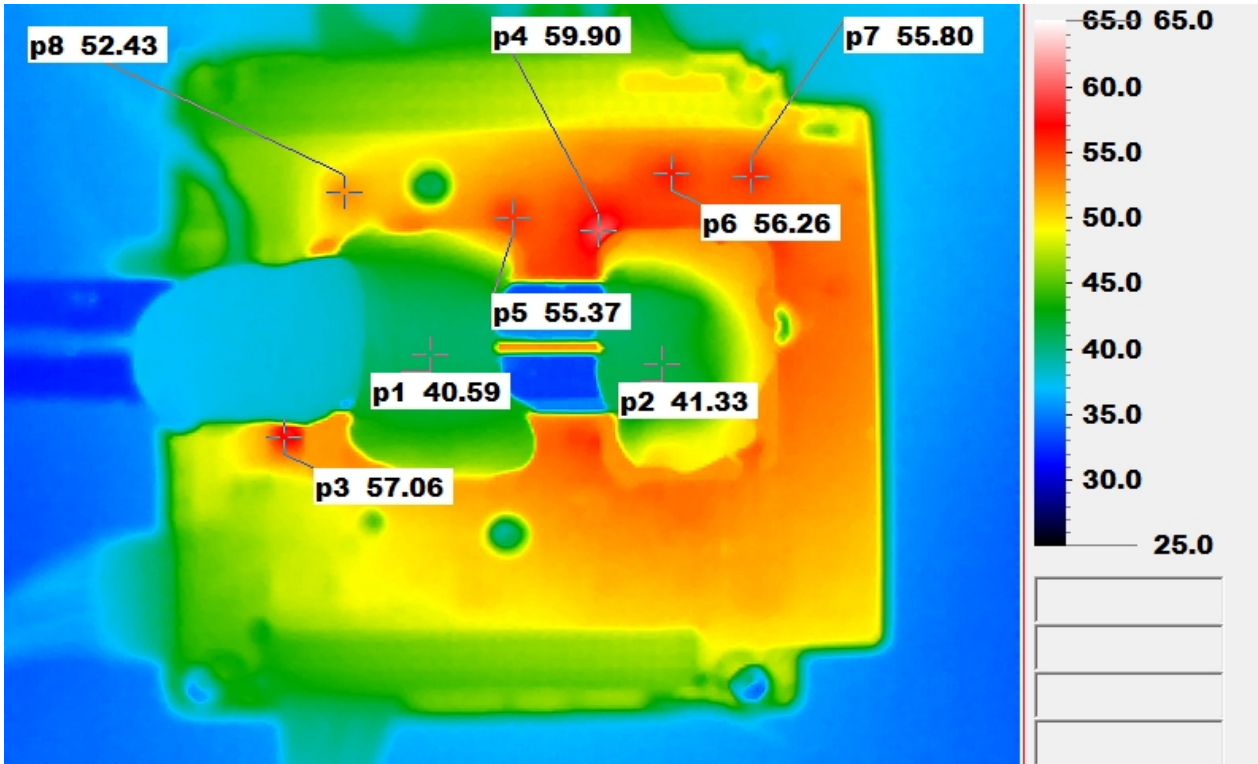
Test by DA-100: 25.1°C with Heat Sink

6. Take Picture Time:

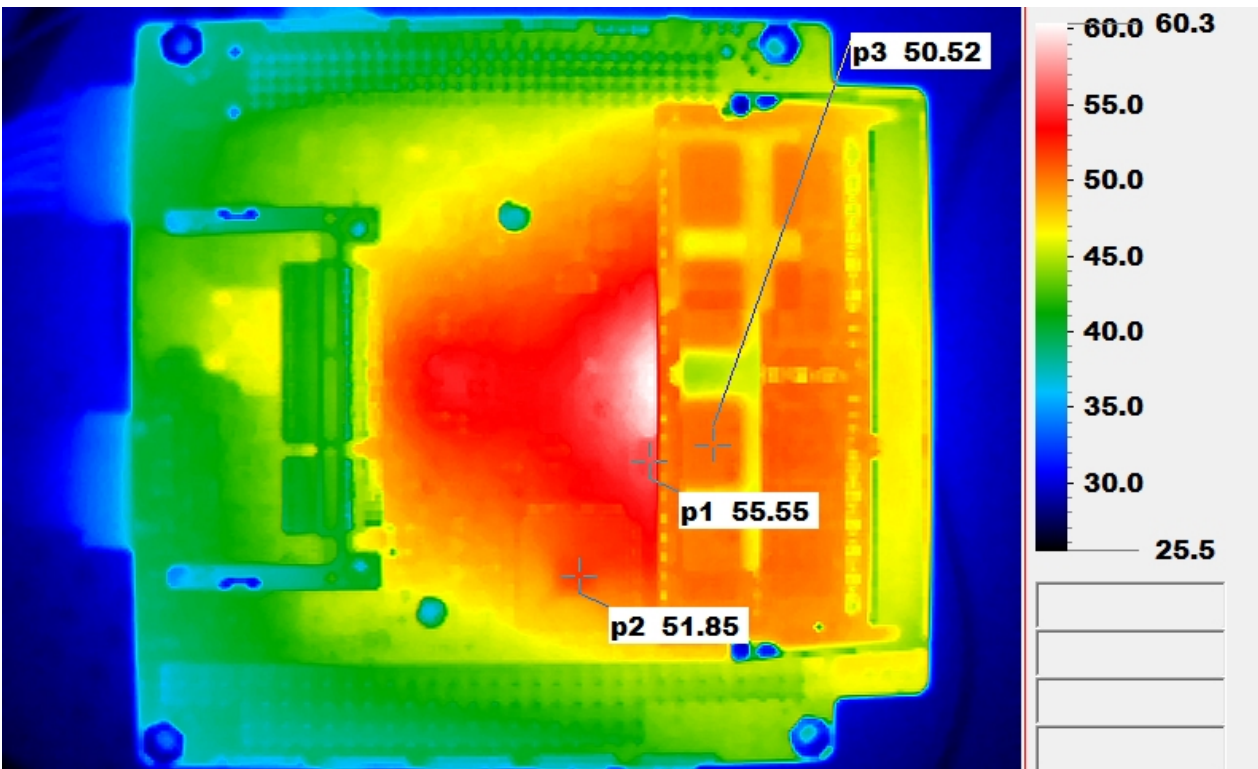
After power on 2 hours

Temperature Profile Test:

Component Side:

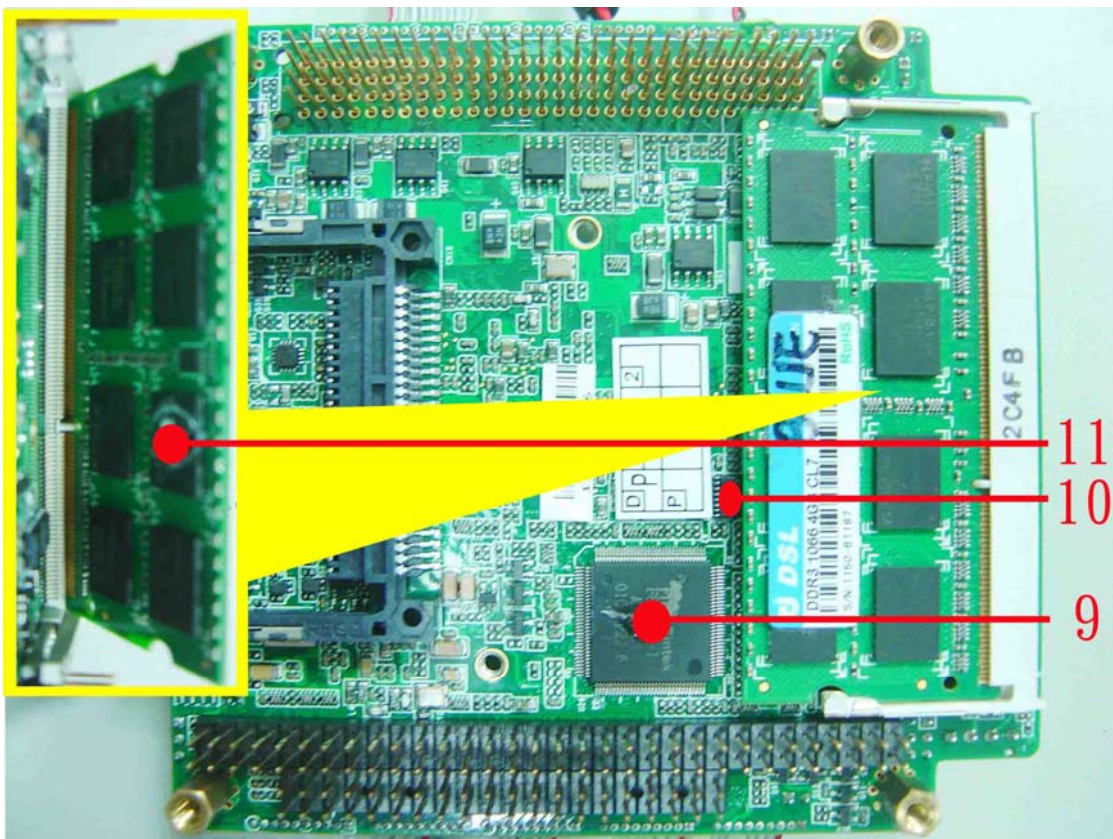
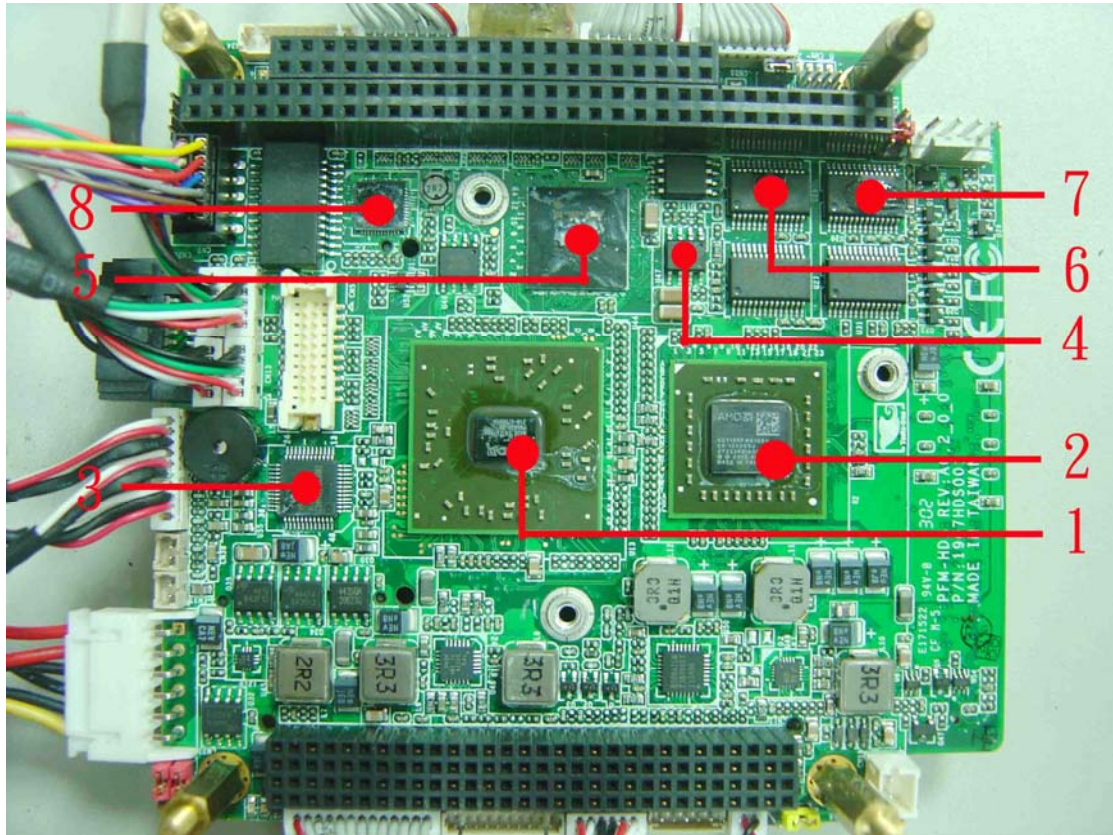


Back Side:



Terminal Recorder:

Measuring Thermal Couple Position :



Using YOKOGAWA / DARWIN DA100-100-13-1D test

| Point | Position | Describe | Tc (*1) (°C) | Tm (*2) Measured Under | | Note |
|-------|----------|---|-----------------|---------------------------|------|-------|
| | | | | 25.1°C | 60°C | |
| 1 | U13 | (TF)AMD.A55E.100-CG2293 | 105 | 48.9 | 83.8 | |
| 2 | U2 | (TF)AMD APU.G-series.615MHz. GET16RFWB12GV.T16R | 90 | 52.3 | 87.2 | Note4 |
| 3 | U55 | (TF)Audio Codec.REALTEK.ALC892-GR | 100.5 | 54.2 | 89.1 | |
| 4 | U47 | (TF)REG. LDO Regulator.UPI.UP0104PSU8 | 100 | 54.8 | 89.7 | |
| 5 | U44 | (TF)PCI to ISA Bridge Chip.ITE.IT8888G-L | 85 | 51.0 | 85.9 | Note4 |
| 6 | U29 | (TF)RS232 Driver ESD 15KV.AD.ADM213EARSZ | 100 | 50.9 | 85.8 | |
| 7 | U28 | (TF)RS232 Driver ESD 15KV.AD.ADM213EARSZ | 100 | 50.8 | 85.7 | |
| 8 | U11 | (TF)Gigabit Ethernet Chip.REALTEK.RTL8111E-VB-GR | 85 | 47.4 | 82.3 | Note4 |
| 9 | U26 | (TF) Super I/O.Fintek.F81866D-I | 127 | 50.3 | 85.2 | |
| 10 | U3 | (TF) VGA ESD Protection Array. Amazing.AZC209-07P | 85 | 50.2 | 85.1 | Note4 |
| 11 | - | Memory chipset | 95 | 53.3 | 88.2 | Note4 |

Note(*):

1. "Tc" indicates the component's case maximum temperature value specified in its datasheet.
2. "Tm" indicates the measured Tc value under working environmental temperature within product specification.
3. Judgment Criteria:
 - Fail : $T_m > T_c + 5^{\circ}\text{C}$; The measured value is over specification plus margin.
 - Margin : $T_c + 5^{\circ}\text{C} > T_m > T_c - 10^{\circ}\text{C}$; The measured value is within specification with margin.
For FANLESS system application, it is strongly recommended to add thermal dissipation design for better reliability.
 - Pass : $T_m < T_c - 10^{\circ}\text{C}$; The measured value is with safety margin.
4. Defect NO. [E120807LABD02](#)